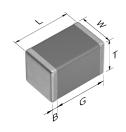
## 积层贴片陶瓷片式电容器

## C2012C0G2E821J060AA

RoHS Reach Halogen Free Pb Free

交货型号	C2012C0G2E821JT****	
用途	一般等级 车载用途时为 <u>CGA4C3C0G2E821J060AA</u> 。	
特点	Mid 中耐压 (100∼630V)	
系列	C2012 [EIA 0805]	
状态	↑ 量产体制(新设计非推荐)	



尺寸		
长度(L)	2.00mm ±0.20mm	
宽度(W)	1. 25mm ±0. 20mm	
厚度(T)	0.60mm ±0.15mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.50mm Min.	
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)	
1世存/开益41/四 (FA)	0.90mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)	
证符/杆皿/印/印 (LD)	0.70mm to 0.90mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)	
3世行/十皿/甲/四 任 0/	0.90mm to 1.20mm (Reflow Soldering)	

电气特性		
电容	820pF ±5%	
额定电压	250VDC	
温度特性	COG (0±30ppm/° C)	
Q (Min.)	1000	
绝缘电阻(Min.)	10000M Ω	

	其他	
焊接方法	流体	
件按月伝	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

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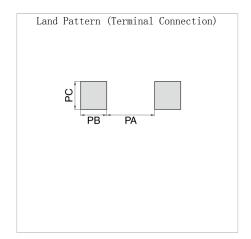
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## Associated Images



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